PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Koutarou KIMURA	10/18/2011
Koji NITTA	10/19/2011
Akihisa HOSOE	10/18/2011
Shinji INAZAWA	10/31/2011
Kazuki OKUNO	10/18/2011
Masatoshi MAJIMA	10/31/2011
Hajime OTA	10/18/2011
Shoichiro SAKAI	10/31/2011
Kengo GOTO	10/18/2011
Tomoyuki AWAZU	11/01/2011

RECEIVING PARTY DATA

Name:	SUMITOMO ELECTRIC INDUSTRIES, LTD.	
Street Address:	5-33, Kitahama 4-chome, Chuo-ku	
City:	Osaka-shi, Osaka	
State/Country:	JAPAN	
Postal Code:	541-0041	

PROPERTY NUMBERS Total: 1

	Property Type	Number
A	pplication Number:	13236041

CORRESPONDENCE DATA

 Fax Number:
 (202)204-0289

 Phone:
 202-842-8800

Email: dcpatentfiling@dbr.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

via US Mail.

Correspondent Name: DRINKER BIDDLE & REATH (DC)

PATENT

REEL: 027315 FRAME: 0797

OP \$40.00 13236041

501742465

Address Line 1: 1500 K STREET, N.W.

Address Line 2: SUITE 1100

Address Line 4: WASHINGTON, DISTRICT OF COLUMBIA 20005-1209

ATTORNEY DOCKET NUMBER: 048404-0077 (475350)

NAME OF SUBMITTER: Peter J. Sistare

Total Attachments: 2

 $source = 048404_0077_Assignment\#page 1.tif\\ source = 048404_0077_Assignment\#page 2.tif$

PATENT REEL: 027315 FRAME: 0798

ATTORNEY DOCKET NO.: 048404-0077 (475350) SOLE/JOINT INVENTION (U.S. Rights Only)

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

METHOD FOR PRODUCING POROUS METAL BODY, POROUS ALUMINUM BODY, BATTERY ELECTRODE MATERIAL INCLUDING POROUS METAL BODY OR POROUS ALUMINUM BODY, AND ELECTRODE MATERIAL FOR ELECTRICAL DOUBLE LAYER CAPACITOR

for which I/WE are filing an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on September 19, 2011, (Serial No. 13/236,041); and

WHEREAS, <u>SUMITOMO ELECTRIC INDUSTRIES</u>, <u>LTD.</u>, a corporation of <u>Japan</u>, whose post office address is <u>5-33</u>, <u>Kitahama 4-chome</u>, <u>Chuo-ku</u>, <u>Osaka-shi</u>, <u>Osaka 541-0041</u>, <u>Japan</u>, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application or any application claiming priority based on this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, or any application claiming priority based on this application, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, or any application claiming priority based on this application, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).

Full Name of Sole or First Assignor Koutarou KIMURA	Assignor's Signature Koutayou Kīmuya	Date October 18, 2011
Address: c/o Osaka Works of Sumitomo Electric Industries, Ltd. 1-3, Shimaya 1-chome, Konohana-ku Osaka-shi, Osaka, Japan		Citizenship Japanese
Full Name of Second Assignor Koji NITTA	Assignor's Signature Koji Mta	Date October 19,2011
Address: c/o Osaka Works of Sumitomo Electric In 1-3, Shimaya 1-chome, Konohana-ku Osaka-shi, Osaka, Japan		Citizenship Japanese

Names of additional inventors attached ⊠Yes ☐ No
Page 1 of 2

DC01/2797250, 1

PATENT REEL: 027315 FRAME: 0799

	Attorney Dock	et No.: 048404-0077 (475350)
Full Name of Third Assignor	Assignor's Signature	Date
Akihisa HOSOE	Akihisa Hosoe	October 18, 2011
Address: c/o Osaka Works of Sumitomo Electric 1-3, Shimaya 1-chome, Konohana-ku Osaka-shi, Osaka, Japan	Industries, Ltd.	Citizenship Japanese
Full Name of Fourth Assignor Shinji INAZAWA	Assignor's Signature Shinji Irayawa	Date October 31, 201
Shinji INAZAWA Address: c/o Osaka Works of Sumitomo Electric Industries, Ltd. 1-3, Shimaya 1-chome, Konohana-ku Osaka-shi, Osaka, Japan		Citizenship Japanese
Full Name of Fifth Assignor Kazuki OKUNO	Assignor's Signature Kazuki OKUNO	Date October 18,2011
Address: c/o Itami Works of Sumitomo Electric Industries, Ltd. 1-1, Koyakita 1-chome Itami-shi, Hyogo, Japan		Citizenship Japanese
Full Name of Sixth Assignor Masatoshi MAJIMA	Assignor's Signature Masatoshi Magni	Date October 31.20//
Address: c/o Osaka Works of Sumitomo Electric Industries, Ltd. 1-3, Shimaya 1-chome, Konohana-ku Osaka-shi, Osaka, Japan		Citizenship Japanese
Full Name of Seventh Assignor Hajime OTA	Assignor's Signature Hajime Ota	Date October 18,2011
Address: c/o Osaka Works of Sumitomo Electric Industries, Ltd. 1-3, Shimaya 1-chome, Konohana-ku Osaka-shi, Osaka, Japan		Citizenship Japanese
Full Name of Eighth Assignor Shoichiro SAKAI	Assignor's Signature Shoichiro Sakai	Date October 31,2011
Address: c/o Osaka Works of Sumitomo Electric Industries, Ltd. 1-3, Shimaya 1-chome, Konohana-ku Osaka-shi, Osaka, Japan		Citizenship Japanese
Full Name of Ninth Assignor Kengo GOTO	Assignor's Signature Kengo Goto	Date October 18, 2011
Address: c/o Osaka Works of Sumitomo Electric I 1-3, Shimaya 1-chome, Konohana-ku Osaka-shi, Osaka, Japan		Citizenship Japanese
Full Name of Tenth Assignor Tomoyuki AWAZU	Assignor's Signature Tomoznki Awazn	Date November 1, 2011
Tomoyuki AWAZU Address: c/o Itami Works of Sumitomo Electric In 1-1, Koyakita 1-chome Itami-shi, Hyogo, Japan	dustries, Ltď.	Citizenship Japanese

Names of additional inventors attached Yes No

Page 2 of 2

DC01/2797250. 1

RECORDED: 12/02/2011

PATENT REEL: 027315 FRAME: 0800